

Study of switching contacts by optical techniques

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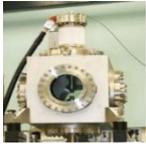
9th ITG International Vacuum Electronics Workshop 2024

August 28 – 30, 2024, Physikzentrum Bad Honnef (www.pbh.de), Germany

Outline



- Introduction/Motivation

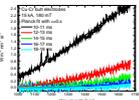


- Experimental setup



- Results and discussion

- Arc dynamics
- Surface morphology
- Surface temperature measurements
- Dielectric withstand after current interruption

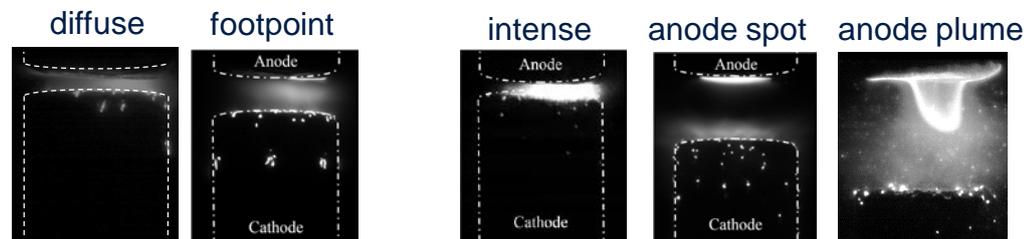


- Summary

Introduction



- Vacuum arcs widely used in switching devices
 - simple design, small number of components
 - environmentally friendly operation – zero emission (no harmful gases, no light emission, no waste products)
- Dual role of electrode evaporation
 - source of the switching medium – metallic vapor arc
 - shorter lifetime due to local thermal load/electrode surface overheating
 - reduce of the switching capacity in case of too high vapor density after current termination
- High neutral metal vapor density caused by anode activity
- Control over the arc behavior and over anode thermal load is necessary
- Monitoring of thermal load and exploration of material limits for high-current operation required



Motivation

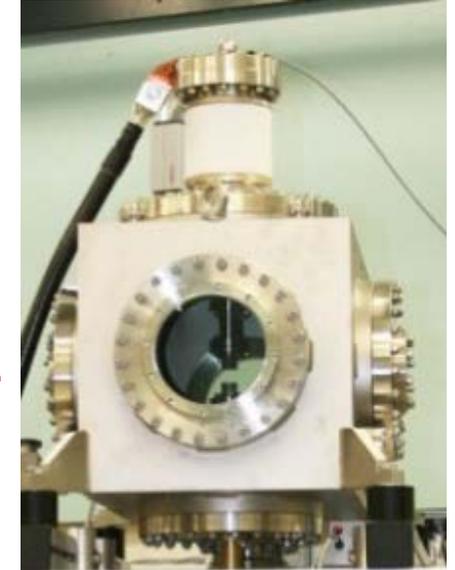
- Exploration of material limits for high-current operation
- Test of applicability of temperature determination method for various materials
- Focus on
 - arc dynamics
 - analysis of surface morphology
 - measurements of anode surface temperature
 - dielectric performance after current interruption



high-speed camera, arc dynamics

high-speed camera, surface temperature
NIR optics

NIR spectrometer



vacuum chamber with moveable electrodes

- Synthetic test circuit- combination of high-current generator 400 A ÷ 7 kA @ 50 Hz and transient recovery voltage (TRV) generator 42 kV@1000 Hz
- Broad use of optical diagnostics: non-invasive methods, quantitative characterization of arc plasma and electrode surface

Experimental setup: electrodes



CuCr



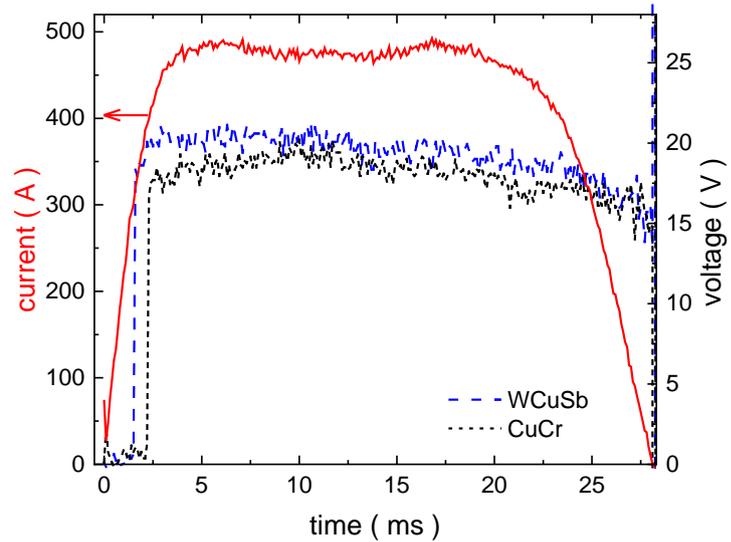
WCuSb

- \varnothing 24 mm
- Max. current 0.5 kA (20 ms pulsed DC), 7 kA (peak, AC 50 Hz)
- Arcing time 3.3 – 9 ms
- Max TRV 21 kV

Results: arc dynamics – DC current

CuCr

WCuSb

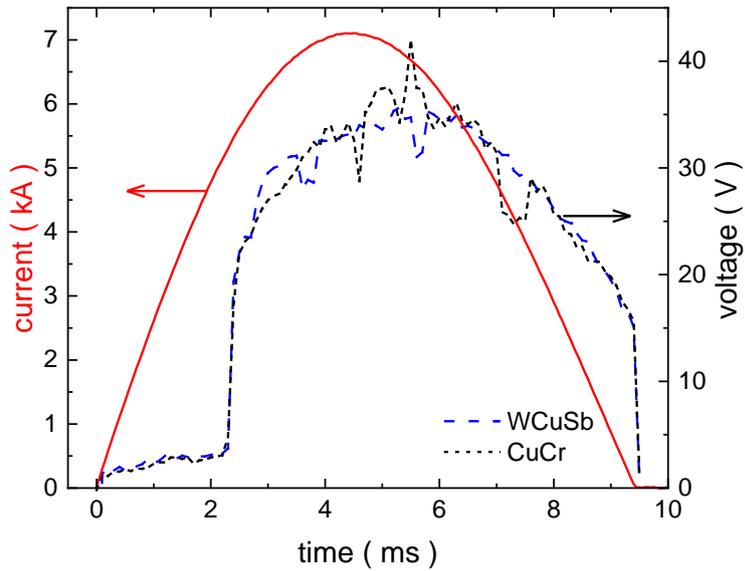


- Higher arc voltage in case of WCuSb electrodes (ca + 2 V)
- Higher cathode spot dynamics in case of CuCr
- Stronger localisation of cathode spots in case of WCuSb

Results: arc dynamics – short circuit AC current

CuCr

WCuSb



- Distinct anode spot formation for CuCr only
- Less influence of material on the arc voltage

Results: Surface morphology



- Arc root on the anode side is moving from shot to shot
- Cathode uniformly loaded by arc, localised arc attachment zones on anode

Results: Surface morphology

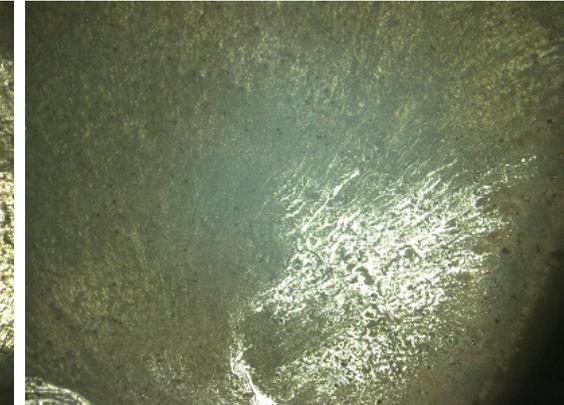
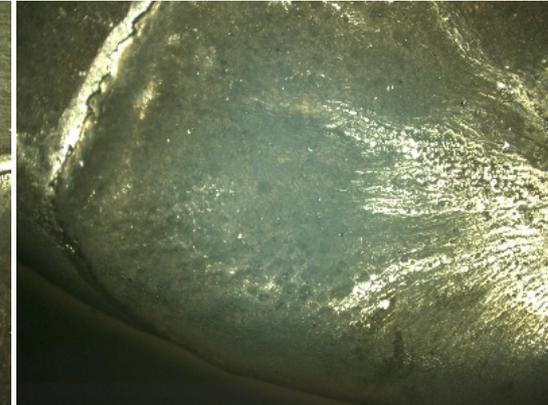
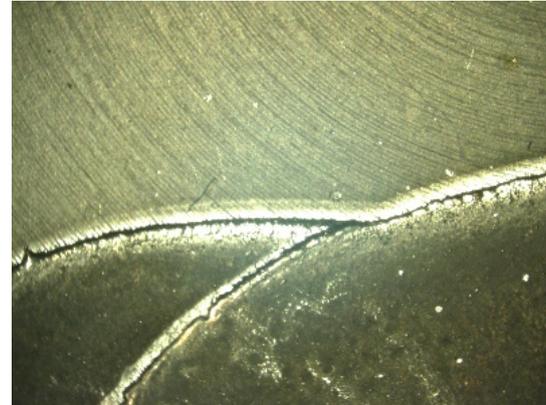
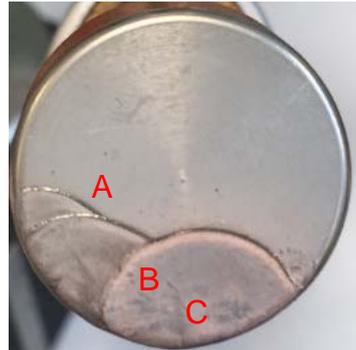
CuCr

A

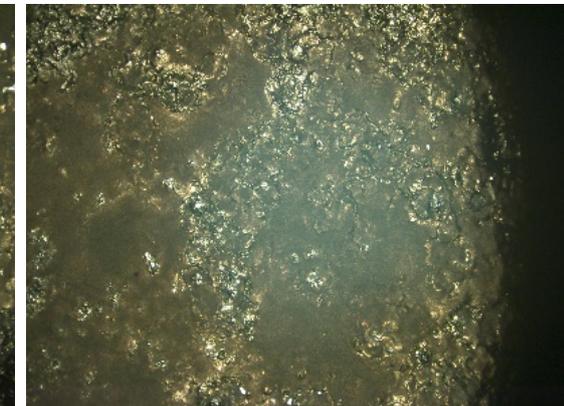
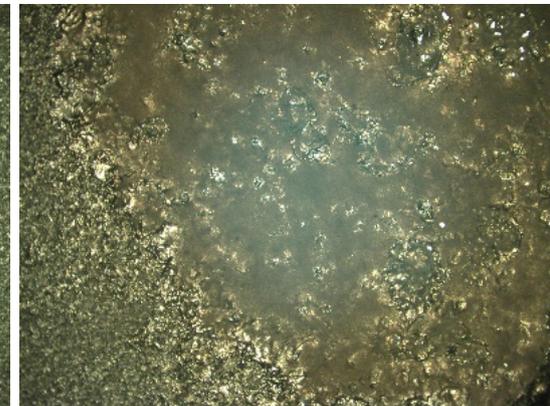
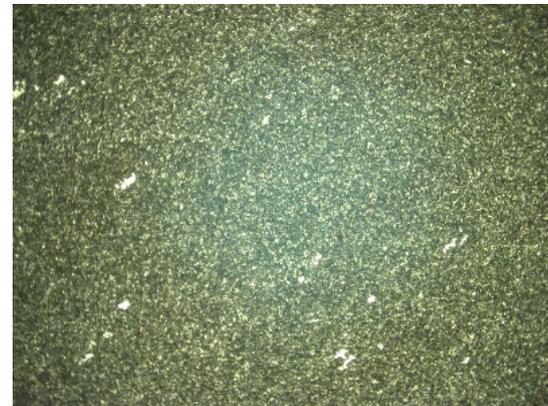
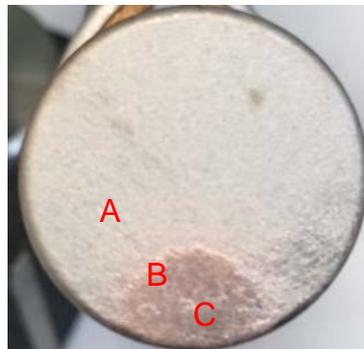
B

C

anode



cathode

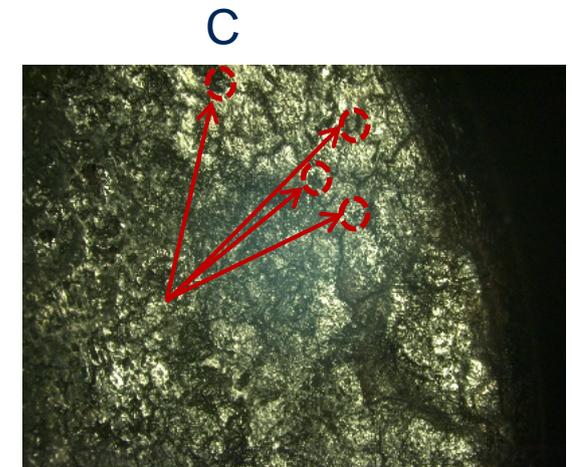
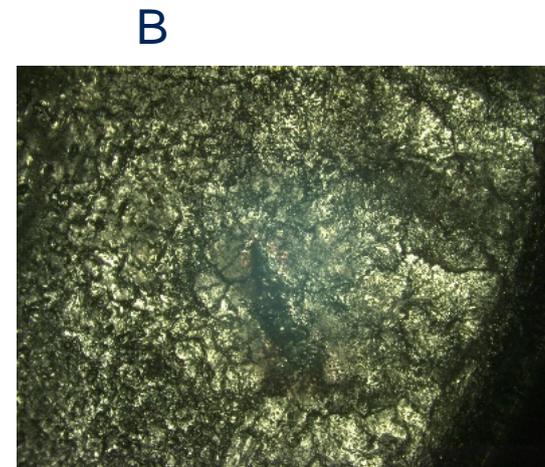
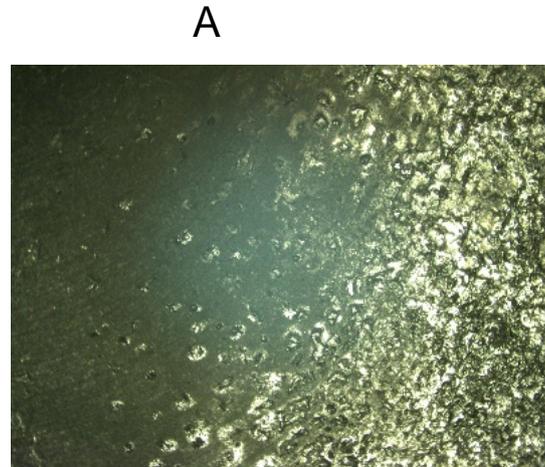


- Cathode uniformly loaded by arc, localised arc attachment zones on anode
- Smooth surface on both electrodes (absence of big droplets and big craters)

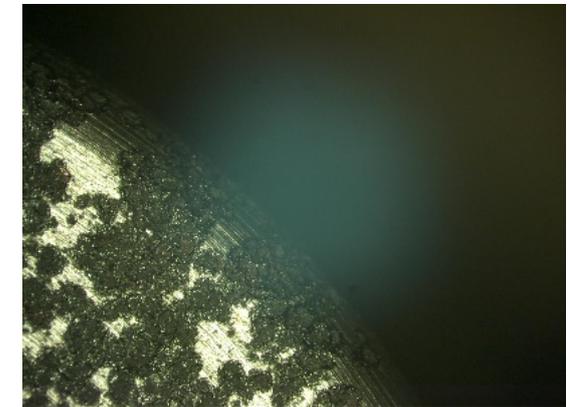
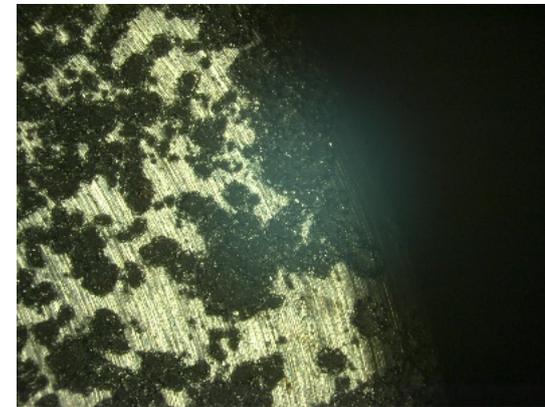
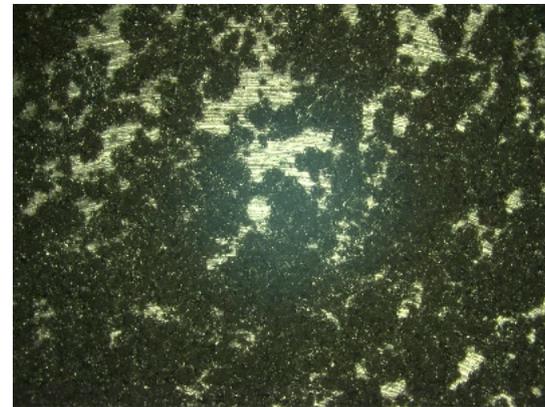
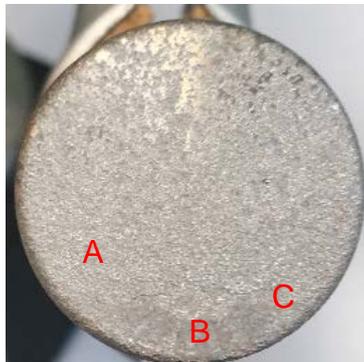
Results: Surface morphology

WCuSb

anode



cathode



- Cathode uniformly loaded by arc, localised arc attachment zones on anode
- Strong changes in anode morphology
- Crater on cathode and spikes on anode

Methods: I. NIR spectroscopy



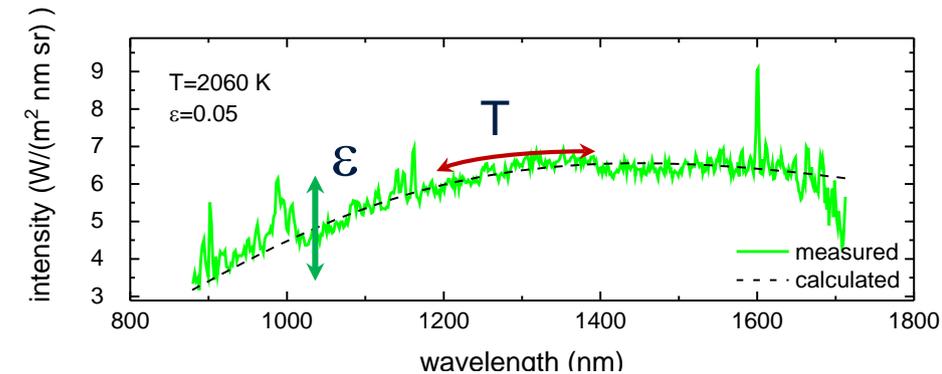
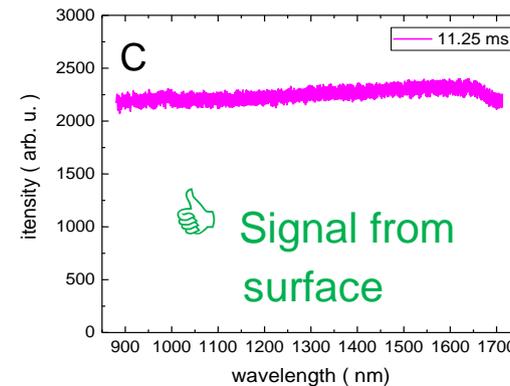
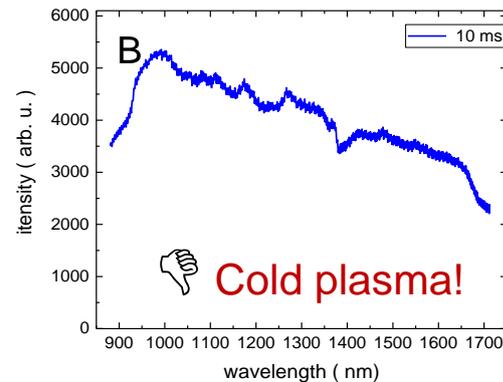
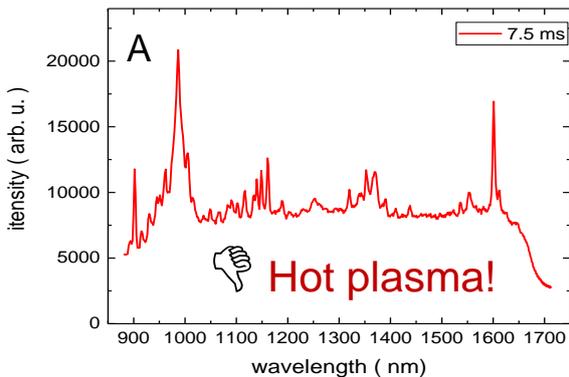
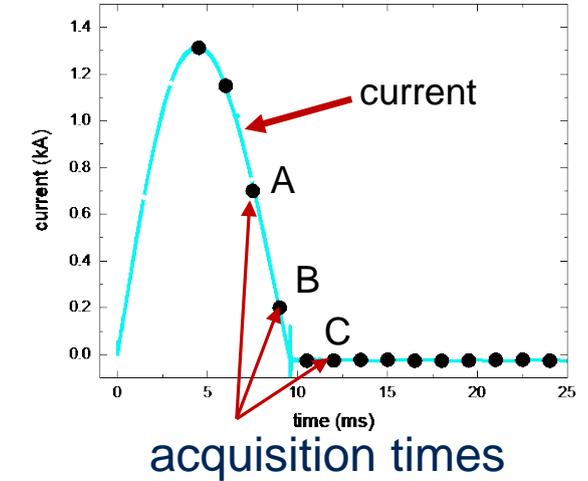
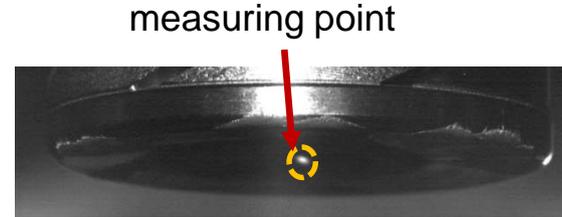
NIR 900-1600 nm

+



NIR optics

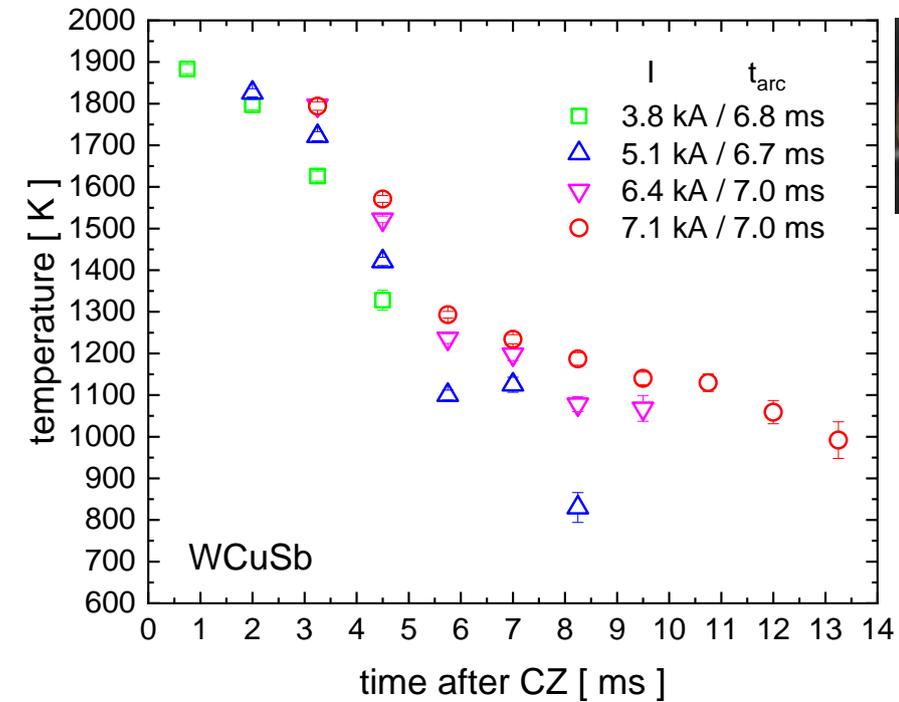
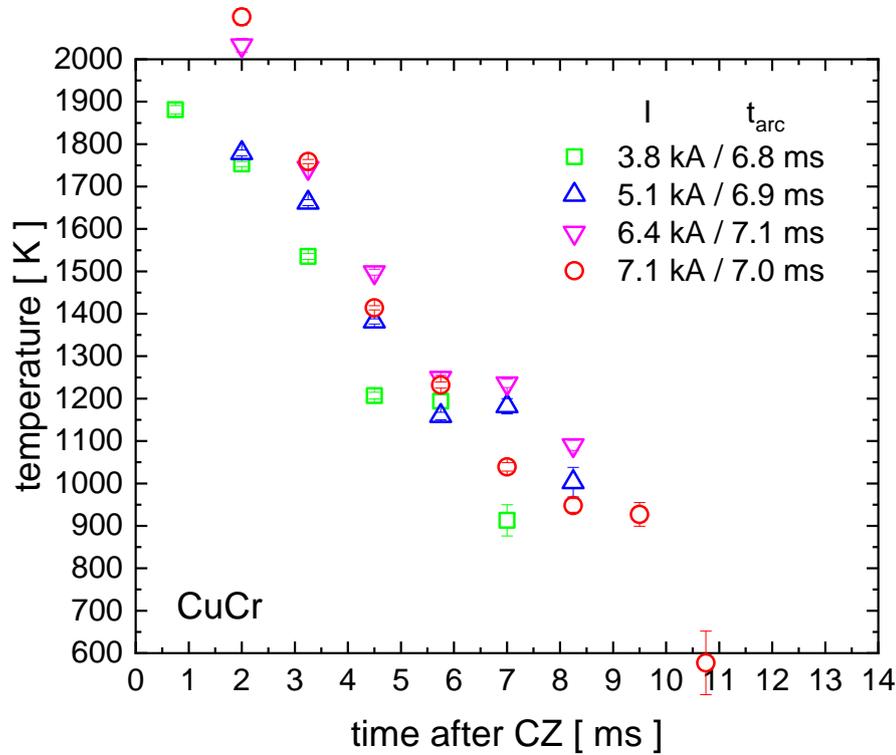
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$$B_{\lambda}(T) = \varepsilon(\lambda, T) \frac{2hc^2}{\lambda^5} \cdot \frac{1}{e^{\frac{hc}{\lambda kT}} - 1}$$

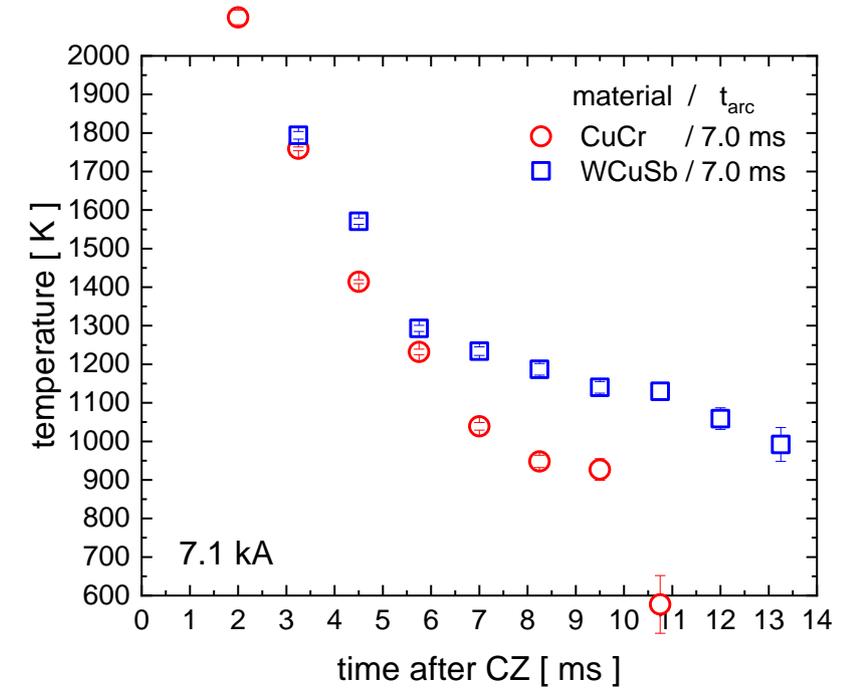
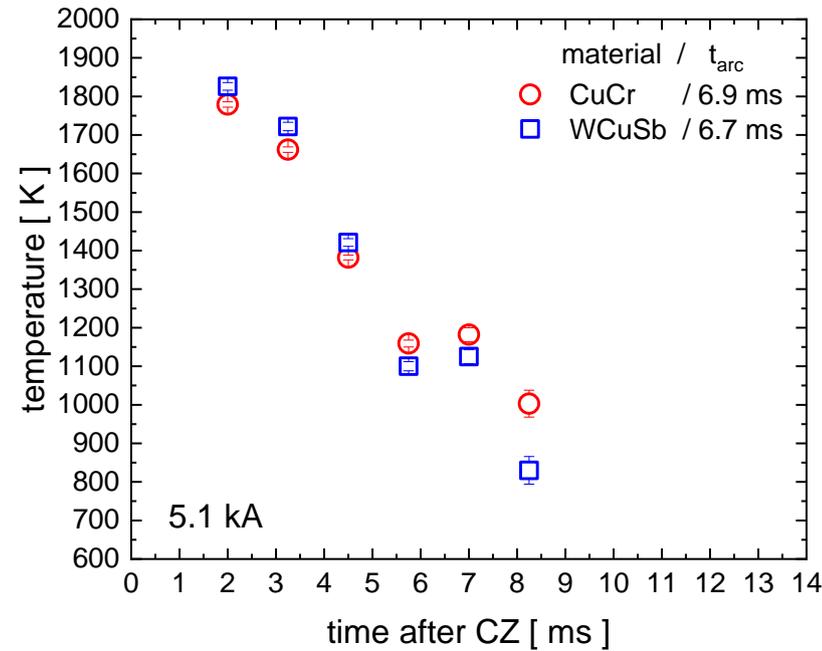
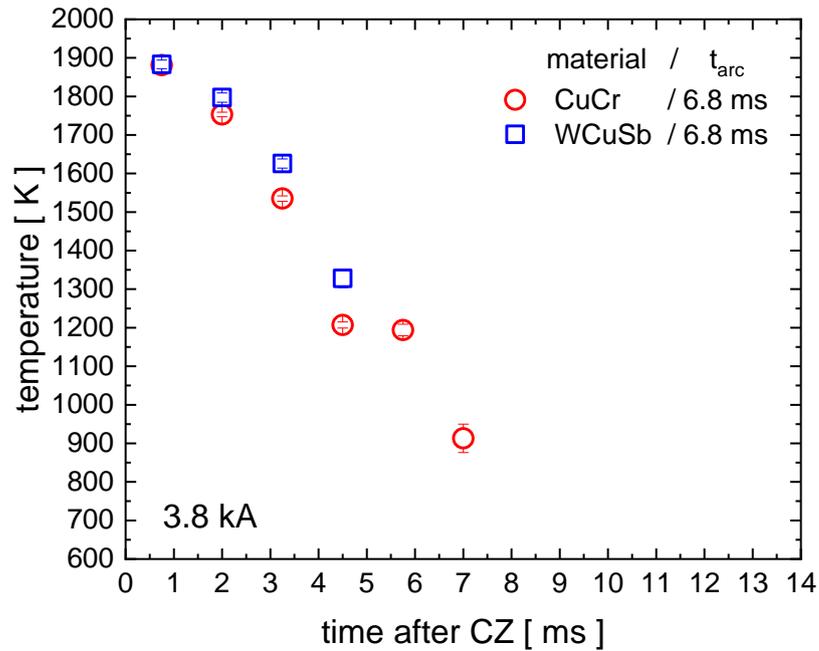
- Evaluation of NIR spectra emitted by hot electrode surface
- Temporal resolution 1.25 ms

Results: anode surface temperature (I) - NIR spectroscopy



- Comparable initial temperature for both materials
- Higher temperature at higher current
- Faster temperature decay in case of CuCr for highest current

Results: anode surface temperature (I) - NIR spectroscopy



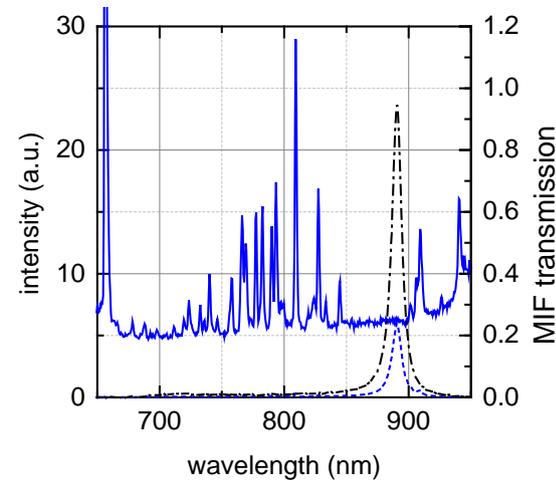
- Comparable initial temperature for both materials
- Longer decay for higher current
- Enhanced temperature in case of WCuSb
- Faster temperature decay in case of CuCr for highest current

Methods: II. High-Speed Camera (HSC) with filter



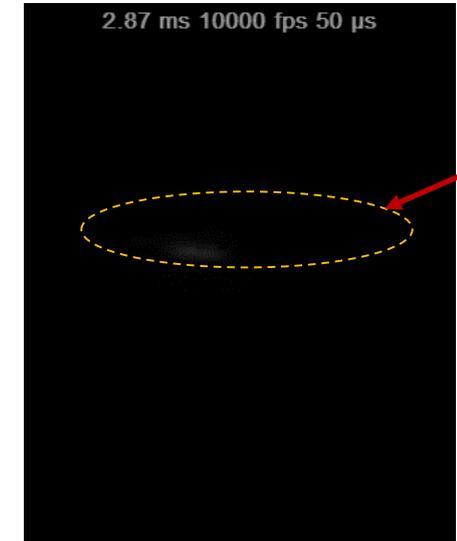
High-speed camera
IDT Motion Pro Y4
5000-20000 fps

+



filter, which “blocks”
plasma radiation

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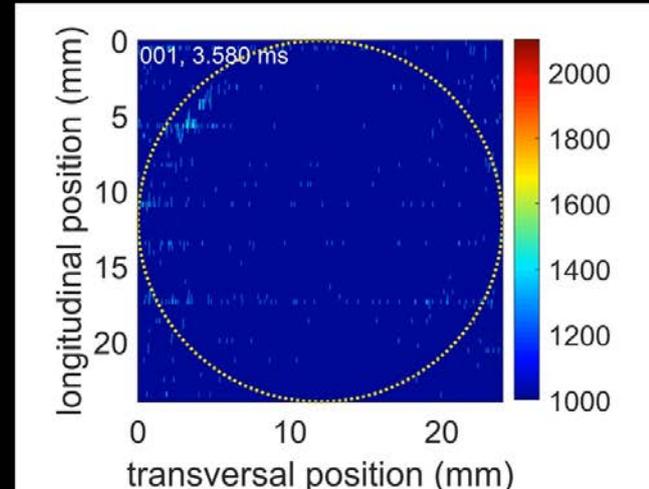
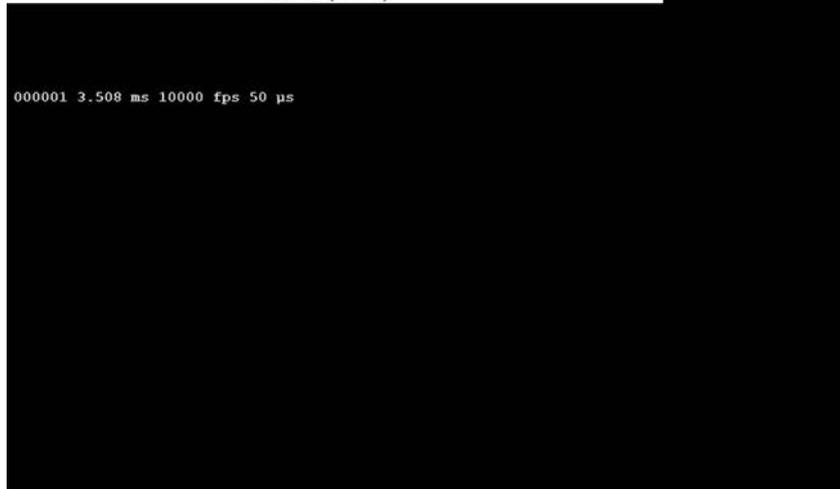
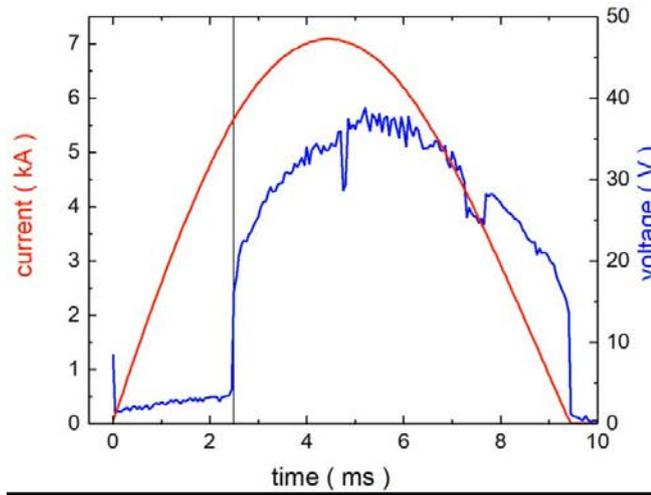


radiation image dominated
by surface contribution

- The method gives **qualitative** 2D temperature distribution with high temporal resolution
- **Quantitative** temperature can be obtained after comparison with results of NIR measurements at certain spatial position and time instant
- Challenge: continuum radiation of plasma must be taken into account (“removed”)
- Subtraction of plasma radiation works well for diffuse arc only !

Results: anode surface temperature (II) – HSC with filter

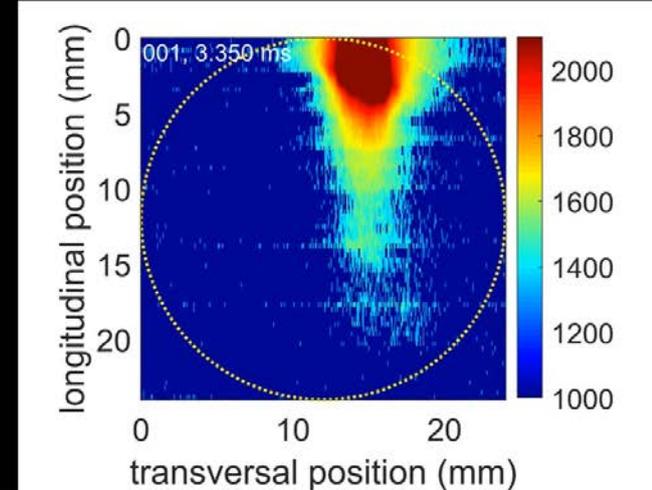
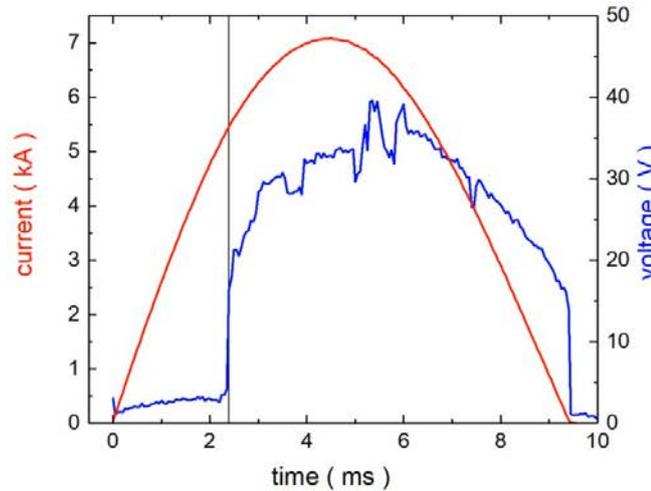
CuCr



- Evaluation possible after current maximum only
- Pronounced anode spot with wide melted region

Results: anode surface temperature (II) – HSC with filter

WCuSb

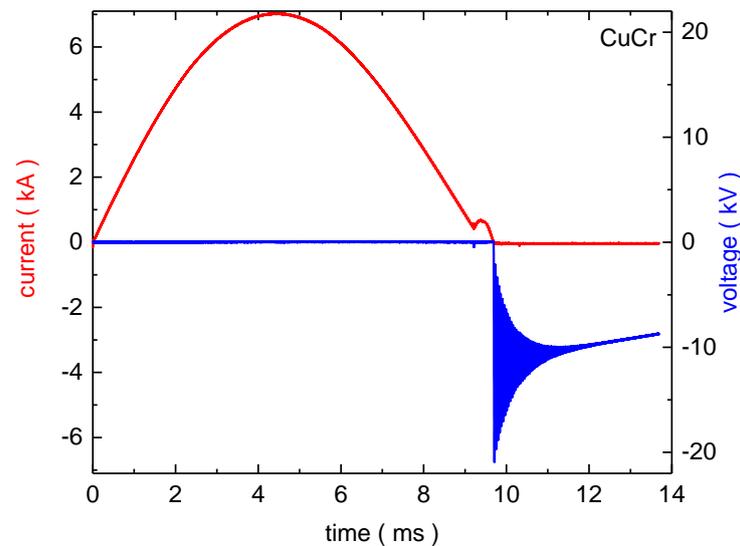


- Evaluation possible after current maximum only
- No pronounced anode spot, but many “hot spots” on the anode

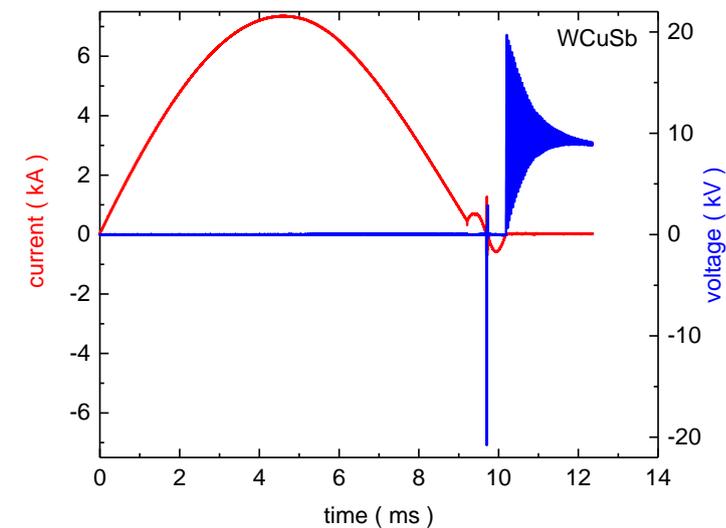
Results: Dielectric withstand after current interruption

Conditions

- Current from 1.1 kA to 7.1 kA (peak)
- Max TRV value 21 kV @ 1000 Hz
- Arc duration 3.3 – 7.4 ms



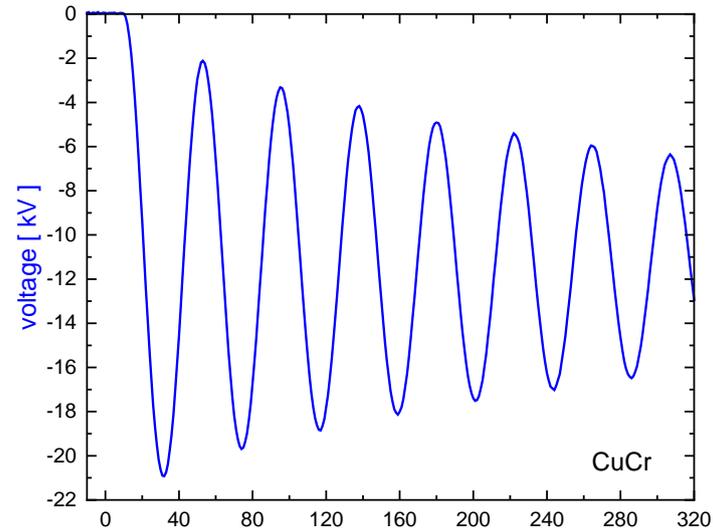
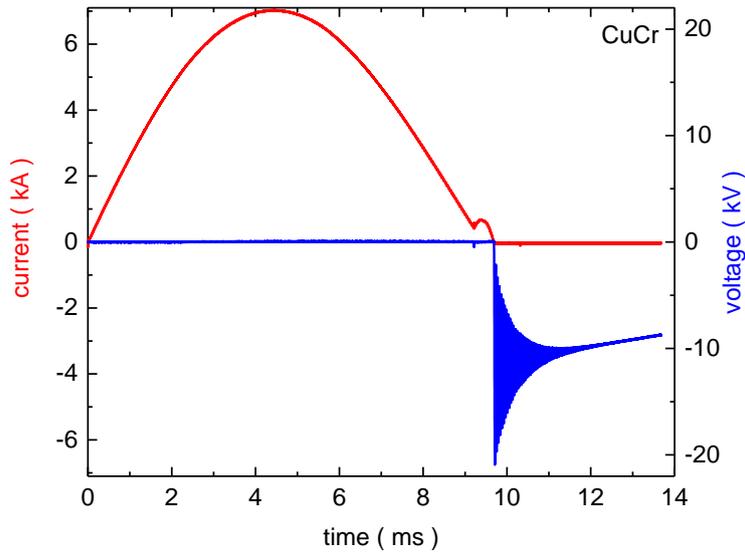
SUCCESS



failure

Results: Dielectric withstand after current interruption

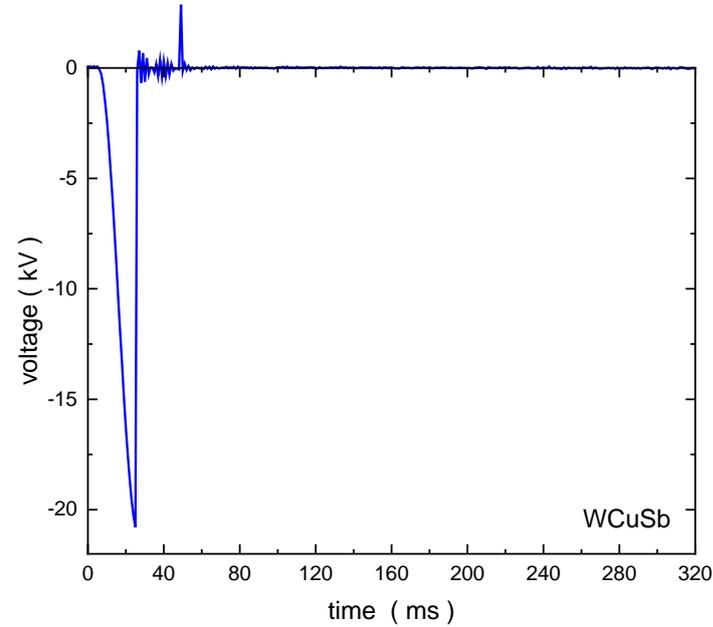
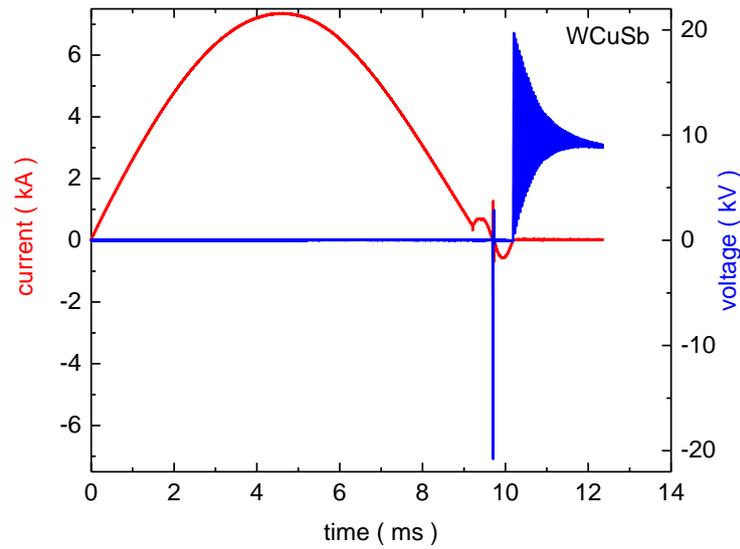
CuCr



- Successful interruption for all conditions: anode spot, anode plume, lateral attachment, droplets on surface ...

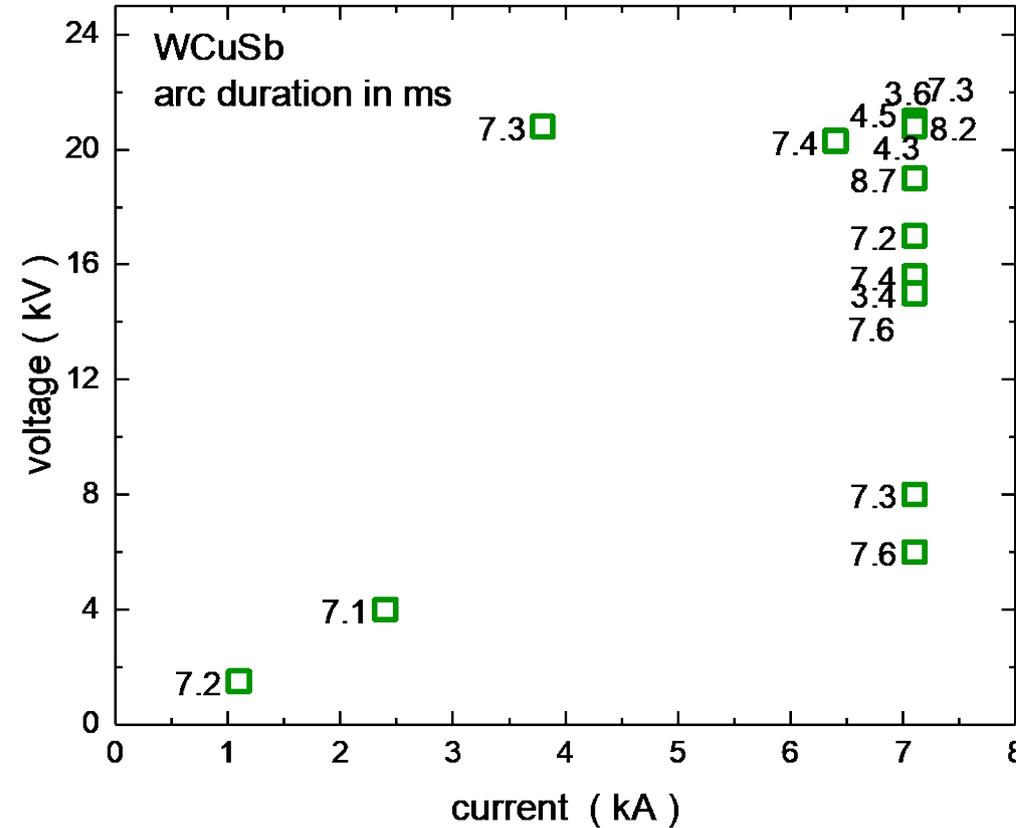
Results: Dielectric withstand after current interruption

WCuSb



- Stable breakdown at all studied conditions

Results: Dielectric withstand after current interruption



- Stable breakdown at all studied conditions, sometimes after second voltage peak
- Possible reasons: hot spots on the anode surface, spikes at the anode surface, stronger droplets formation

Summary

- Various optical methods for determination of surface temperature have been successfully tested for different electrode materials
- Formation of micro structures on WCuSb electrodes – craters on cathode, spikes on anode – causes breakdown after TRV application
- Comparable anode surface temperatures for CuCr and WCuSb at the instant of current zero crossing
- Longer temperature decay for higher current and longer arc duration
- Longer temperature decay in case of WCuSb for highest current

Thank you very much for your attention!



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